

CABLINE[®]-SS Connector

Part No. Plug: 20380-***T-**, Receptacle: 20374-***E-**-*

Product Specification

Qualification Test Report No. TR-04037

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Rev.	ECN	Date	Prepared by	Checked by	Approved by

1. Scope

This Product Specification defines the test conditions and the performances of the CABLINE-SS Connector, a wire-to-board connector of 0.4 mm contact pitch.

2. Product Name and Parts No.

2.1 Product Name

CABLINE-SS

2.2 Parts No.

- (1) CABLINE-SS PLUG FOR CABLE ASSEMBLY (Part No. 20380-***T-**)
 - CABLINE-SS PLUG HOUSING ASSEMBLY (Part No. 20373-***T-0*-*)
 - CABLINE-SS METAL COVER (Part No. 2182-0**-0**)
- (2) CABLINE-SS RECEPTACLE ASSEMBLY (Part No. 20374-***E-**-*)

3. Rating

3.1 Applicable Cable

Micro-Coaxial Cable ...AWG#【42, 40, 38, 36】

Discrete Wire ...AWG#【36, 34】

3.2 Operating Conditions

Amperage: 0.24A	AC/DC [AWG#42]	(Per Contact Pin/Up to 50 Contacts)
0.25A	AC/DC [AWG#40]	(Per Contact Pin/Up to 50 Contacts)
0.30A	AC/DC [AWG#40]	(Per Contact Pin/Up to 32 Contacts)
0.33A	AC/DC [AWG#38]	(Per Contact Pin/Up to 50 Contacts)
0.50A	AC/DC [AWG#38]	(Per Contact Pin/Up to 12 Contacts)
0.35A	AC/DC [AWG#36]	(Per Contact Pin/Up to 50 Contacts)
0.40A	AC/DC [AWG#36]	(Per Contact Pin/Up to 37 Contacts)
0.80A	AC/DC [AWG#36]	(Per Contact Pin/Up to 4 Contacts)
0.35A	AC/DC [AWG#34]	(Per Contact Pin/Up to 50 Contacts)
1.00A	AC/DC [AWG#34]	(Per Contact Pin/Up to 2 Contacts)

※Testing by a real machine is recommended because temperature rise may be affected by actual situation

Voltage: 100V AC (per contact pin)

Operating temperature: 233~358K(-40°C~85°C)

(Containing temperature rise by current)

Operating humidity: 85% max. (Non-Condensing)

3.3 Storage Conditions

Storage temperature: 248~333K(-25°C~60°C)

Storage humidity: 85% max. (Non-condensing)

Storage period:

Before opening ... 1 year after product is delivered.

After opening, use it as soon as possible.

4. Test and Performance

Test Condition

This initial test is equal to it's at shipping condition and unless otherwise specified, all tests and measurements shall be performed under the following conditions in accordance with MIL-STD-202.

Temperature... 288 K~308 K (15 °C~35 °C)

Pressure... 866 hPa~1066 hPa (650 mmHg~800 mmHg)

Relative humidity... 45~75 %R.H.

4.1. Electrical Performance

1. Contact resistance

Reference standard: MIL-STD-202, Method 307

Test conditions: Solder the receptacle connector to the test board and mate the plug connector together, then measure the contact resistance as shown in Fig.1 by the four terminal methods. Apply the low level condition of 20 mV MAX. DC for the open circuit voltage and 10 mA MAX. DC for the closed circuit current.

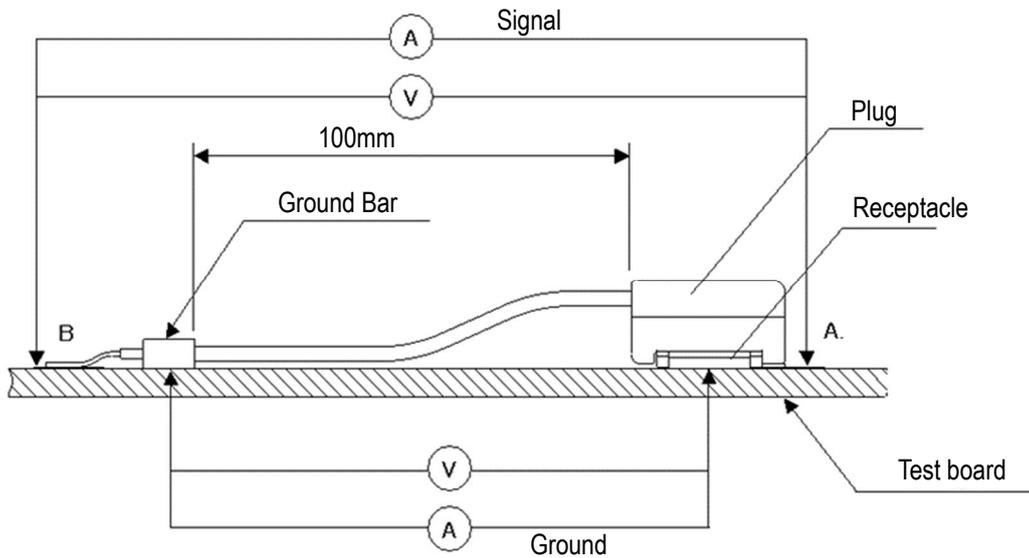


Figure 1

Pass criteria:

Contact

Initial: 180 mΩ MAX.(AWG#34) 275 mΩ MAX.(AWG#36) 360 mΩ MAX.(AWG#38)

Initial: 600 mΩ MAX.(AWG#40) 700 mΩ MAX.(AWG#42)

After testing: ΔR 40 mΩ MAX.

Initial contains the following conductor resistance of a cable 100 mm.

100 mΩ(AWG#34) 195 mΩ(AWG#36) 280 mΩ(AWG#38)

520 mΩ(AWG#40) 620 mΩ(AWG#42)

Ground Shell

Initial: 50 mΩ MAX. After testing: ΔR 40 mΩ MAX.

4.1. Electrical Performance

2. Insulation resistance	
Reference standard:	MIL-STD-202, Method 302
Test conditions:	Mate the plug and receptacle connector together, then apply DC 250 V between the neighboring contacts.
Pass criteria:	Initial: 1,000 MΩ MIN. After testing: 500 MΩ MIN.

3. Dielectric withstanding voltage	
Reference standard:	MIL-STD-202, Method 301
Test conditions:	Mate the receptacle and plug connector together, then apply AC 250V(rms)between the neighboring contacts for a minute.
Pass criteria:	No creeping discharge, flashover, no insulator breakdown shall occur.

4. Temperature rising	
Reference standard:	-
Test conditions:	Mate the plug and receptacle connector together and then apply rating current per contact pin.
Pass criteria:	Over ambient $\Delta T30\text{ }^{\circ}\text{C MAX.}$

4.2. Mechanical Performance

1. Mating force and Un-mating force				
Reference standard: -				
Test conditions: Solder the receptacle connector to the test board, then place the board and plug on push-on/pull-off machine, measure of initial and mating/unmating 30 cycles at a speed $25 \pm 3\text{ mm/min.}$ along the mating axis.				
Pass criteria:	Mating force		Un-mating force	
		Initial and 30 cycles		Initial 30 cycles
	10 P	29.0 N MAX.	10 P	4.00 N MIN. 2.87 N MIN.
	14 P	29.8 N MAX.	14 P	4.40 N MIN. 3.23 N MIN.
	20 P	31.0 N MAX.	20 P	5.00 N MIN. 3.76 N MIN.
	30 P	33.0 N MAX.	30 P	6.00 N MIN. 4.65 N MIN.
	32 P	33.4 N MAX.	32 P	6.20 N MIN. 4.84 N MIN.
	35 P	34.0 N MAX.	35 P	6.50 N MIN. 5.07 N MIN.
	40 P	35.0 N MAX.	40 P	7.00 N MIN. 5.50 N MIN.
	50 P	38.0 N MAX.	50 P	8.00 N MIN. 6.41 N MIN.
	Au Type Mating force		Un-mating force	
		Initial 30 cycles		Initial 30 cycles
	35 P	40.8 N MAX. 34.0 N MAX.	35 P	5.26 N MIN. 3.07 N MIN.
	40 P	42.0 N MAX. 35.0 N MAX.	40 P	6.00 N MIN. 3.50 N MIN.

4.3. Environmental Performance

1. Thermal shock	
Reference standard:	MIL-STD-202, Method 107, Condition A.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 218 K(-55 °C), 30 min.→358K(85 °C), 30 min. Transition time: 5 min. MAX. No. of cycles: 5 cycles
Pass criteria:	Contact resistance: Shall meet 4.1.1.

2. High temperature life	
Reference standard:	MIL-STD-202, Method 108, Condition B.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 358 ± 2 K (85 ± 2 °C) Duration: 250 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Contact retention force: Shall meet 4.2.3.

3. Humidity(Steady state)	
Reference standard:	MIL-STD-202, Method 103, Condition A.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 313 ± 2 K (40 ± 2 °C) Humidity: 90~95 %RH Duration: 240 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Insulation resistance: Shall meet 4.1.2. Dielectric withstanding voltage: Shall meet 4.1.3.

4. Humidity(Cycling)	
Reference standard:	MIL-STD-202, Method 106.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 298 [263]~338 K (25 [-10]~65 °C) Humidity: 90~98 %RH Duration: 10 cycles (240hours)
Pass criteria:	Contact resistance: Shall meet 4.1.1. Insulation resistance: Shall meet 4.1.2. Dielectric withstanding voltage: Shall meet 4.1.3.

5. Salt water spray	
Reference standard:	MIL-STD-202, Method 101, Condition B.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 308 ± 2 K (35 ± 2 °C) Salt water density: 5 ± 1 % [by weight] Duration: 48 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1.

4.3. Environmental Performance

6. H ₂ S gas	
Reference standard:	-
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 313 ± 2 K (40 ± 2 °C) Relative humidity: 80 ± 5 %RH Gas: H ₂ S 3 ppm Duration: 96 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur.

7. Cold Temperature Life	
Reference standard:	-
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment in accordance. Temperature : 233 ± 2 K (-40 ± 2 °C) Duration : 250 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1.

4.4. Others

1. Solder ability	
Reference standard:	MIL-STD-202, Method 208.
Test conditions:	Dip the solder tine of the contact in the solder bath at $518 \pm 5 \text{ K}$ ($245 \pm 5 \text{ }^\circ\text{C}$) for 5 ± 0.5 seconds after immersing the tine in the flux of RMA or R type for 5 to 10 seconds.
Pass criteria:	More than 95 % of the dipped surface shall be evenly wet.

2. Soldering heat resistance

Reference standard: -

Test conditions:
(Reflow) Reflow temperature as shown in Fig.2.
The number of times of Reflow is within 1. However, when it executes the 2 times of reflow or the N2 reflow, we recommend the Ni barrier type.

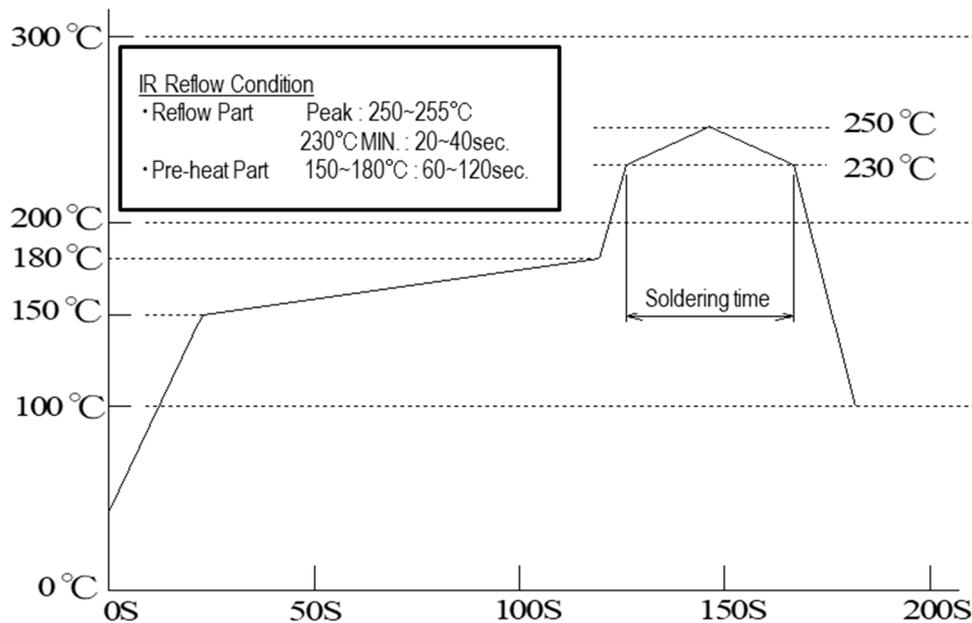


Figure 2

Pass criteria: No abnormality adversely affecting the performance shall not occur.

Test conditions:
(Soldering iron) Operating temperature : 613~633K ($350^\circ\text{C} \pm 10$)
Application time of soldering iron : 5 ± 1 sec.
The number of times of application : 3times

Pass criteria: No abnormality adversely affecting the performance shall not occur.

4.5 Test Sequence and Specimen Quantity

Table 1. Test Sequence and Sample Quantity

Test Item	Group												
	A	B	C	D	E	F	G	H	J	K	L	M	N
C/T Resistance	2,6		1,3,5	1,3	1,3	1,5	1,5,7	1,3	1,3	1,3		.	
Insulation Resistance						2,6	2,8						
D. W. Voltage						3,7	3,9						
Temperature rising													1
Mating Force	1,5												
Un-mating Force	3,7												
Durability	4						4 (10cycles)						
Contact Retention Force		1,3											
Cable Retention Force	8												
Vibration			2										
Shock			4										
Thermal Shock				2									
High Temp. Life		2			2								
Humidity (Steady State)						4							
Humidity (Cycling)							6						
Salt Water Spray								2					
H2S Gas									2				
Cold Temperature Life										2			
Solder ability											1		
Soldering Heat Resistance												1	
Sample QTY.	5 pcs.	20 pcs.	5 pcs.	5 pcs.	5 pcs.	5 pcs.	5 pcs.	5 pcs.	5 pcs.	5 pcs.	10 pcs.	10 pcs.	5 pcs.

※Numbers indicate sequence in which tests are performed.

5. Recommended Metal Mask

Refer to drawing for the recommended metal mask thickness and opening dimension.

6. Precautions for Handling Cable Connectors

Refer to instruction manual:HIM-04001 for the handling of CABLINE-SS.